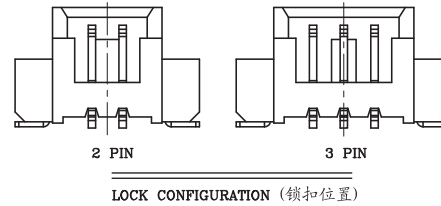
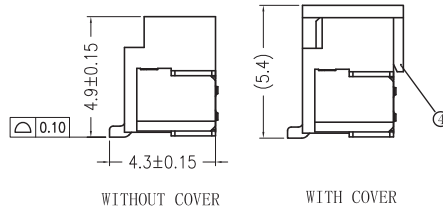
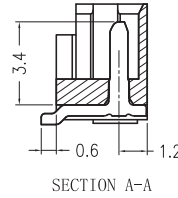
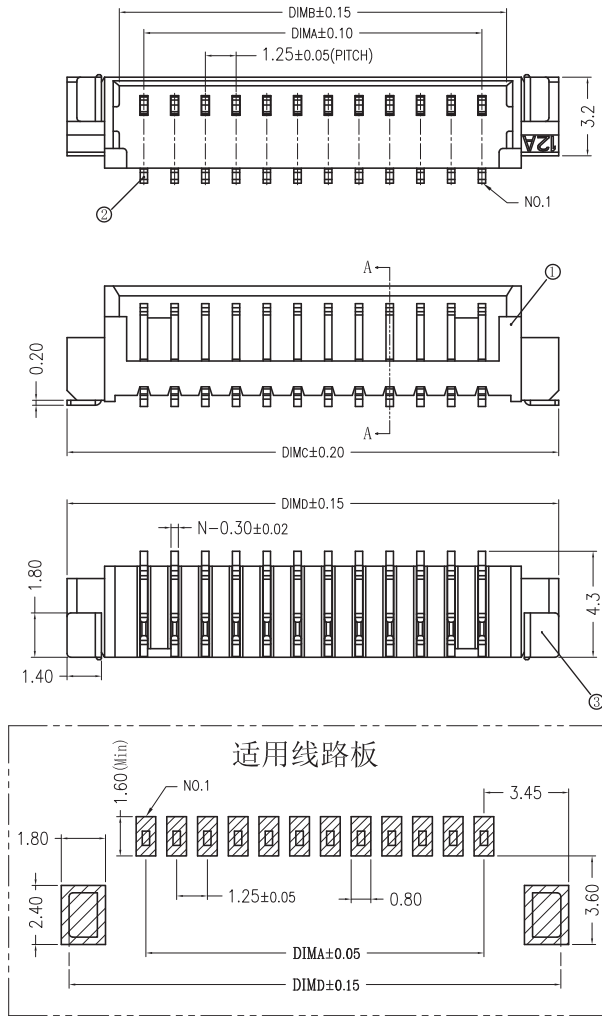


RoHS+REACH



LOCK CONFIGURATION (锁扣位置)

序号	项目	描述	备注
1	塑胶	LCP	
2	端子	黄铜	
3	焊片	黄铜	
4	盖子	LCP	

技术指标:

1. 塑件表面应光洁、无毛边、无明显收缩、缺陷、裂纹等现象。
2. 温度范围: $-25^{\circ}\text{C}\sim 85^{\circ}\text{C}$ 。
3. 额定电压: 125V, AC/DC。
4. 接触电阻: $\leq 20\text{m}\Omega$ 。
5. 绝缘电阻: $\geq 1000\text{M}\Omega$ 。
6. 额定电流: 1A, AC/DC。

CKT	DimA	DimB	DimC	DimD
2	1.25	3.25	7.50	7.50
3	2.50	4.50	8.75	8.75
4	3.75	5.75	10.00	10.00
5	5.00	7.00	11.25	11.25
6	6.25	8.25	12.50	12.50
7	7.50	9.50	13.75	13.75
8	8.75	10.75	15.00	15.00
9	10.00	12.00	16.25	16.25
10	11.25	13.25	17.50	17.50
11	12.50	14.50	18.75	18.75
12	13.75	15.75	20.00	20.00
13	15.00	17.00	21.25	21.25
14	16.25	18.25	22.50	22.50
15	17.50	19.50	23.75	23.75

6.0			
5.0			
4.0			
3.0			
2.0			
1.0			
REV.	DATE	DESCRIPTION	DRAWING

DRAWING:
Frank

CHECKED:
yangjie

APPROVAL:

GENERAL TOLERANCE

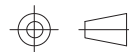
.X:= ± 0.30 .X*:= $\pm 2^{\circ}$
.XX:= ± 0.20 .XX*:= $\pm 1^{\circ}$
.XXX:= ± 0.10 .XXX*:= $\pm 0.5^{\circ}$

UNIT: MM

SCALE: 1/1

SHEET: 1/1

PROJECTION:



CHIN-BAN
Electronic Technology

DESCRIPTION: 1.25mm Wire To Board Wafer SMT

PART NO:

OLD CODE: WF125US-XXX-01

DRAWING NO:

REV: 1.0

SIZE: A4